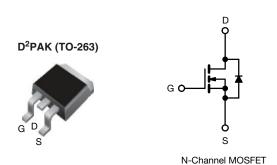
Vishay Siliconix

HALOGEN

# Power MOSFET



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	100			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 5 V 0.077			
Q <sub>g</sub> max. (nC)	64			
Q <sub>gs</sub> (nC)	9.4			
Q <sub>gd</sub> (nC)	27			
Configuration	Single			

### **FEATURES**

- Surface-mount
- Available in tape and reel
- Dynamic dv/dt rating
- · Repetitive avalanche rated
- Logic-level gate drive
- R<sub>DS(on)</sub> specified at V<sub>GS</sub> = 4 V and 5 V
- 175 °C operating temperature
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

#### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D<sup>2</sup>PAK (TO-263) is a surface-mount power package capable of accommodating die size up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface-mount package. The D<sup>2</sup>PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface-mount application.

ORDERING INFORMATION					
Package	D <sup>2</sup> PAK (TO-263)	D <sup>2</sup> PAK (TO-263)			
Lead (Pb)-free and halogen-free	SiHL540S-GE3	SiHL540STRL-GE3 a			
Lead (Pb)-free	IRL540SPbF	IRL540STRLPbF <sup>a</sup>			

#### Note

a. See device orientation

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		$V_{DS}$	100	V	
Gate-source voltage		$V_{GS}$	± 10	V	
Continuous drain current $V_{GS} \text{ at 5 V} \qquad \frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$		I <sub>D</sub>	28		
Continuous drain current	20		Α		
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	110			
Linear derating factor		1.0	W/°C		
Linear derating factor (PCB mount) e		0.025	VV/ C		
Single pulse avalanche energy b	E <sub>AS</sub>	440	mJ		
Avalanche current <sup>a</sup>	I <sub>AR</sub>	28	Α		
Repetitive avalanche energy <sup>a</sup>		E <sub>AR</sub>	15	mJ	
Maximum power dissipation $T_C = 25  ^{\circ}C$		P <sub>D</sub>	150	10/	
Maximum power dissipation (PCB mount) $^{\rm e}$ $T_{\rm A} = 25  ^{\rm o}{\rm C}$			3.7	W	
Peak diode recovery dv/dt <sup>c</sup>	dv/dt	5.5	V/ns		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	00		
Soldering recommendations (peak temperature) d		300	°C		

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11) b.  $V_{DD}=25$  V, starting  $T_J=25$  °C, L=841  $\mu H$ ,  $R_g=25$   $\Omega$ ,  $I_{AS}=28$  A (see fig. 12) c.  $I_{SD}\leq 28$  A,  $di/dt\leq 170$  A/ $\mu$ s,  $V_{DD}\leq V_{DS}$ ,  $T_J\leq 175$  °C d. 1.6 mm from case

- When mounted on 1" square PCB (FR-4 or G-10 material)

S20-0684-Rev. D, 07-Sep-2020



# Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62		
Maximum junction-to-ambient (PCB mount) <sup>a</sup>	R <sub>thJA</sub>	-	40	°C/W	
Maximum junction-to-case (drain)	$R_{thJC}$	-	1.0		

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				L	L	L	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0, I <sub>D</sub> = 250 μA	100	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.12	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.0	-	2.0	V
Gate-source leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 10 V	-	-	± 100	nA
7		V <sub>DS</sub> =	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	25	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA
Data and a state of the state o		$V_{GS} = 5 V$	I <sub>D</sub> = 17 A <sup>b</sup>	-	-	0.077	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4 V	I <sub>D</sub> = 14 A <sup>b</sup>	-	-	0.11	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 50 V, I <sub>D</sub> = 17 A <sup>b</sup>	12	-	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		2200	-	pF
Output capacitance	C <sub>oss</sub>				560	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1.	.0 MHz, see fig. 5	-	140	-	
Total gate charge	Qg			-	-	64	nC
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 5 V$	$V_{GS} = 5 \text{ V}$ $I_D = 28 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 b		-	9.4	
Gate-drain charge	Q <sub>gd</sub>		see lig. o and 10	-	-	27	1
Turn-on delay time	t <sub>d(on)</sub>				8.5	-	ns
Rise time	t <sub>r</sub>	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 28 A,		-	170	-	
Turn-off delay time	t <sub>d(off)</sub>	$R_g = 9.0 \Omega$ ,	$R_g = 9.0 \ \Omega, R_D = 1.7 \ \Omega, \text{ see fig. } 10^{\text{ b}}$		35	-	
Fall time	t <sub>f</sub>				80	-	
Internal drain inductance	L <sub>D</sub>	6 mm (0.25") t	Between lead, 6 mm (0.25") from		4.5	-	ъЦ
Internal source inductance	L <sub>S</sub>	package and center of die contact		-	7.5	-	- nH
<b>Drain-Source Body Diode Characteristic</b>	es						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	28	A
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	_	110	
Body diode voltage	V <sub>SD</sub>	$T_J = 25  ^{\circ}\text{C},  I_S = 28  \text{A},  V_{GS} = 0  \text{V}^{ \text{b}}$		-	-	2.5	V
Body diode reverse recovery time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 28 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}^{\text{b}}$		-	200	260	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	1.7	2.9	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn					

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %



# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

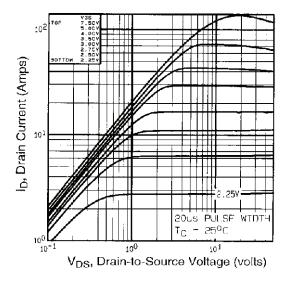


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

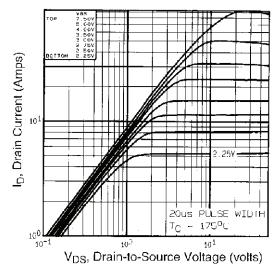


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

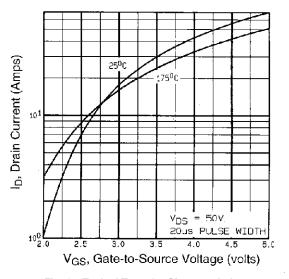


Fig. 3 - Typical Transfer Characteristics

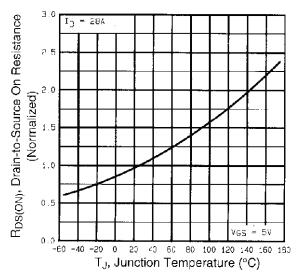


Fig. 4 - Normalized On-Resistance vs. Temperature



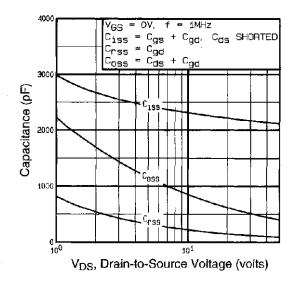


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

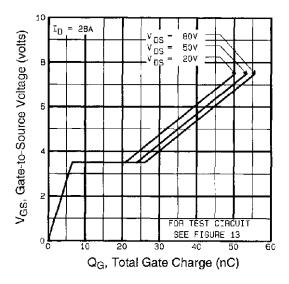


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

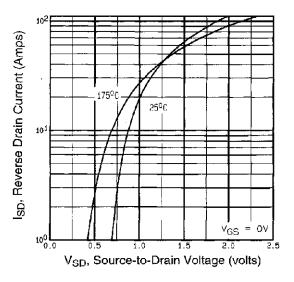


Fig. 7 - Typical Source-Drain Diode Forward Voltage

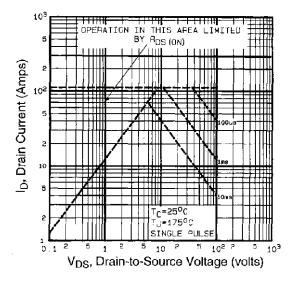


Fig. 8 - Maximum Safe Operating Area



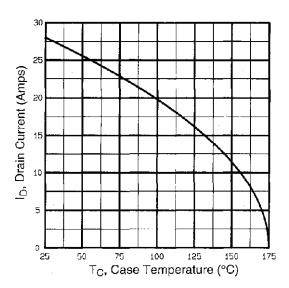


Fig. 9 - Maximum Drain Current vs. Case Temperature

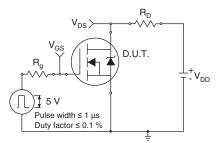


Fig. 10a - Switching Time Test Circuit

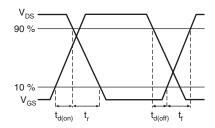


Fig. 10b - Switching Time Waveforms

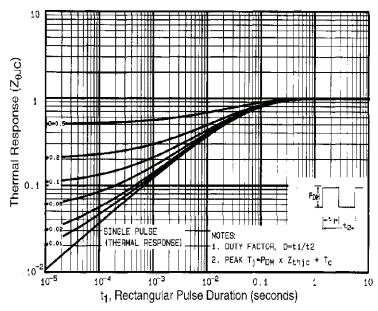


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

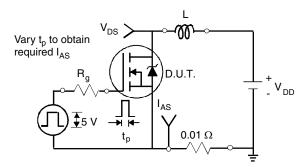


Fig. 12a - Unclamped Inductive Test Circuit

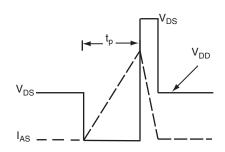


Fig. 12b - Unclamped Inductive Waveforms

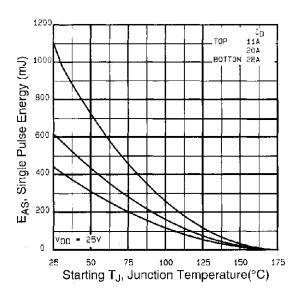


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

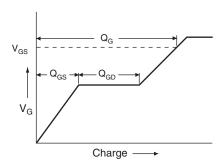


Fig. 13a - Basic Gate Charge Waveform

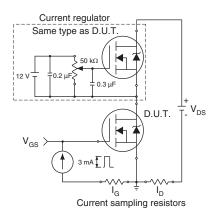
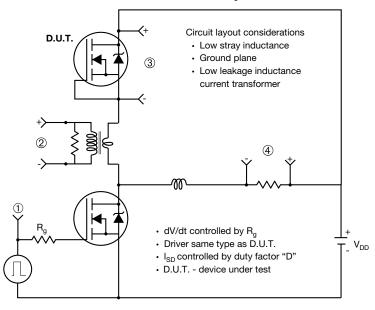


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



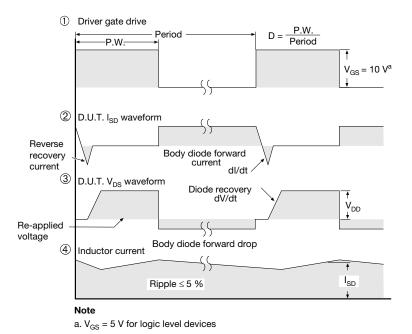


Fig. 14 - For N-Channel

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# **TO-263AB (HIGH VOLTAGE)**







	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	ı
е	2.54 BSC		0.100 BSC	
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	ı	0.066
L2	-	1.78	-	0.070
L3	0.25 BSC		0.010	BSC
L4	4.78	5.28	0.188	0.208

ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

### Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 www.vishay.com Revision: 15-Sep-08





# RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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